



# Computational Fermi level engineering and doping-type conversion of Ga<sub>2</sub>O<sub>3</sub> via three-step processing

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# Fermi Level Engineering of Mg-doped $\text{Ga}_2\text{O}_3$ with Hydrogen

- $\text{Ga}_2\text{O}_3$  is intrinsically n-type and using extrinsic dopants its n-type conductivity can easily be tuned<sup>1,2</sup>
- However, p-type doping faces obstacles<sup>3,4</sup>

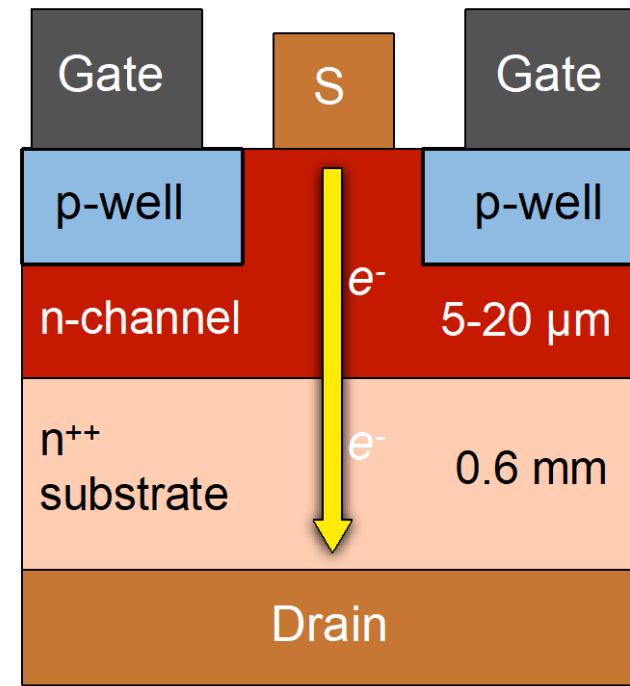
## Motivation:

- P-type doping of Mg:GaN with hydrogen<sup>5</sup>
- Potential application of  $\text{Ga}_2\text{O}_3$  in devices<sup>1,6</sup>

## Key results:

- Type conversion ( $N_A > N_D$ ) of Mg-doped  $\text{Ga}_2\text{O}_3$
- Fermi level pushed below mid gap
- Free electron density greatly suppressed

## Vertical Transistor



<sup>1</sup>S. J. Pearson et al., *Appl. Phys. Rev.*, **2018**, 5, 011301

<sup>2</sup>S. Lany, *APL Mater.*, **2018**, 6, 046103

<sup>3</sup>J. L. Lyons, *Semicond. Sci. Technol.*, **2018**, 33, 05LT02

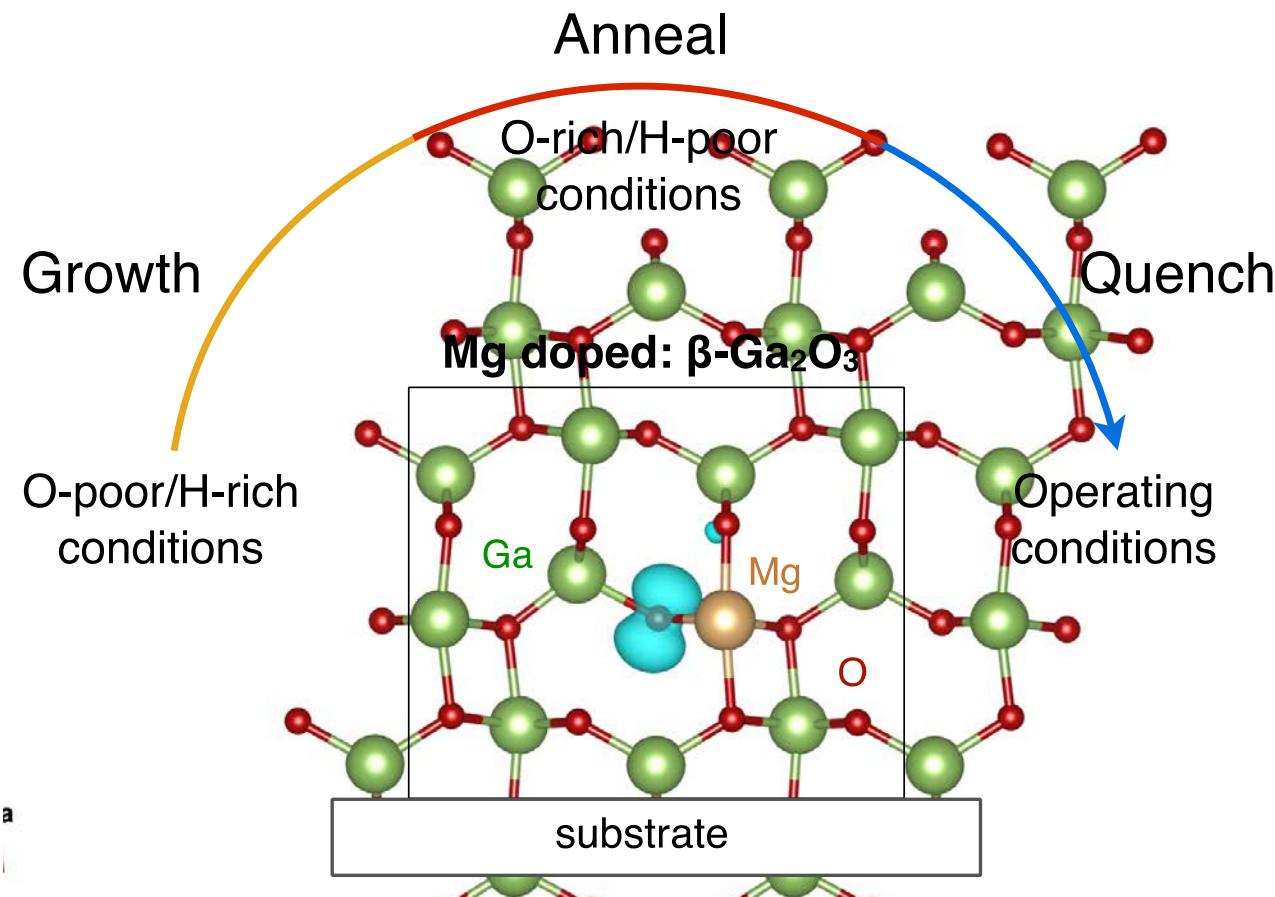
<sup>4</sup>J. B. Varley et al., *J. Phys. Condens. Matter*, **2011**, 23, 334212

<sup>5</sup>S. Nakamura et al., *Jpn. J. Appl. Phys.*, **1992**, 31, 1258–1266

<sup>6</sup>S. B. Reese, A. Zakutayev et al., *Joule* **2019**, 3 903-907

# Three-Step Processing Applied to Mg-doped Ga<sub>2</sub>O<sub>3</sub> with H

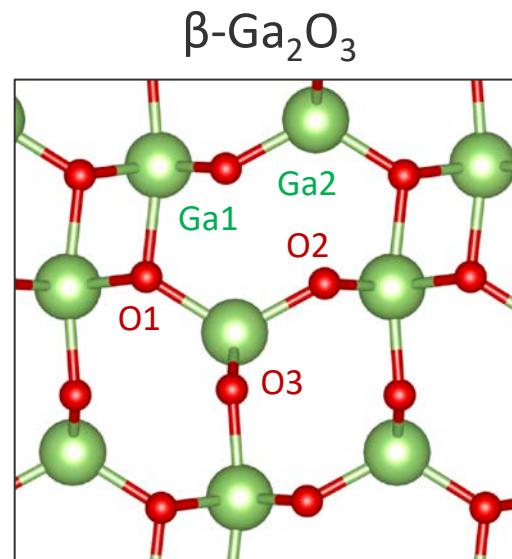
- Estimate thermodynamic conditions ( $T$ ,  $p\text{O}_2$ ,  $p\text{H}_2\text{O}$ ) that maximizes net acceptor concentrations



# Methodology: Thermodynamic Modeling Workflow

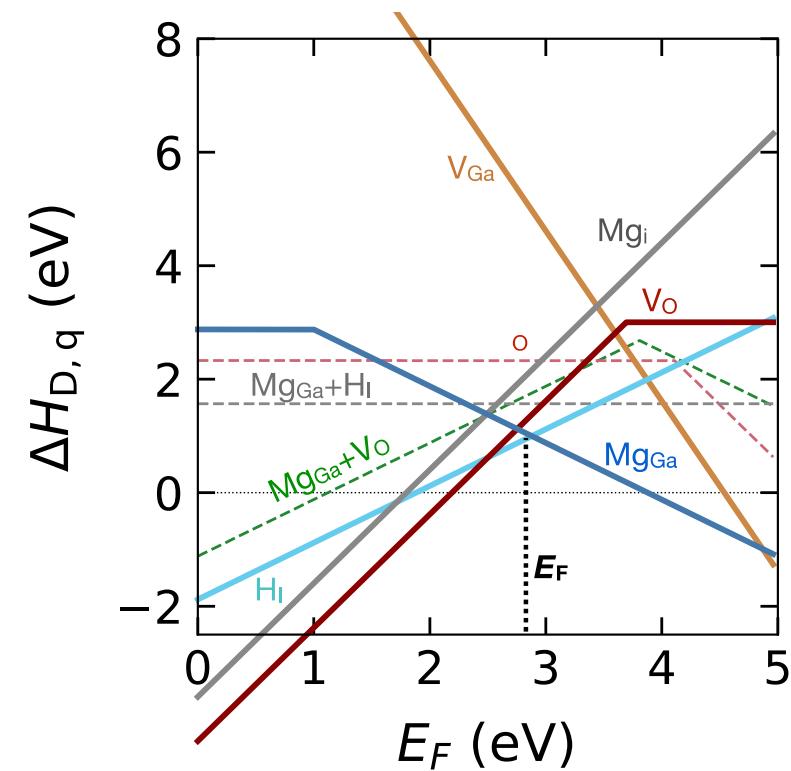
## 1. Relax atomic structure

Atomic and electronic structure  
relaxation using DFT



## 2. Calculate defect formation energy

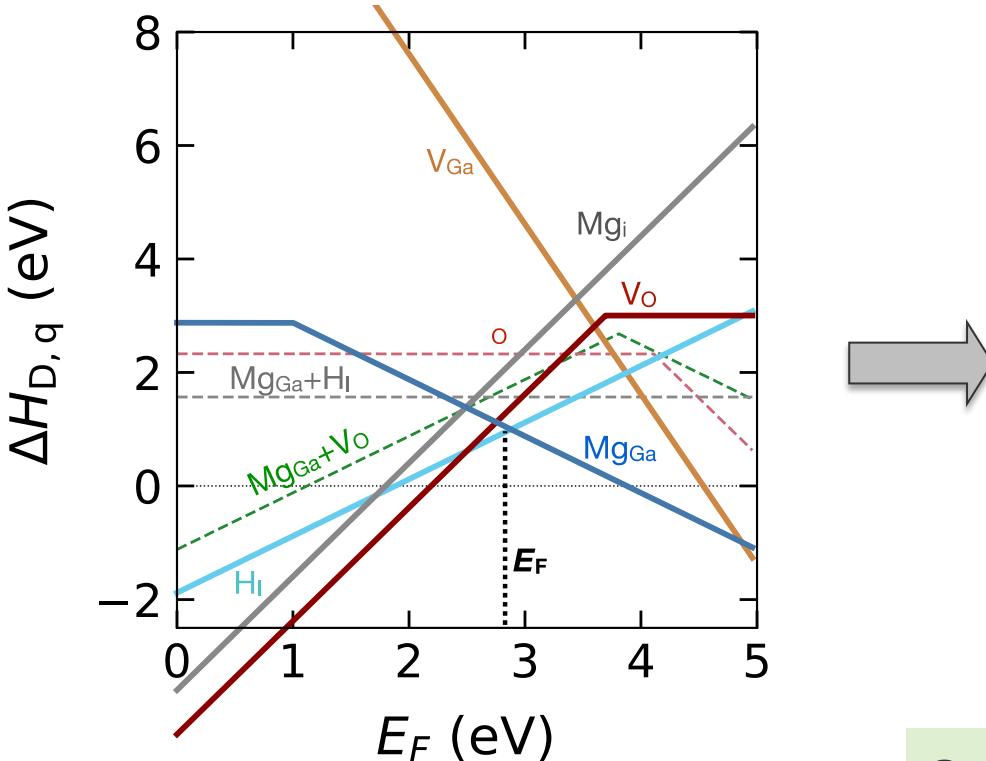
Identify important intrinsic defects,  
dopants, impurities and defect-pairs



# Methodology: Thermodynamic Modeling Workflow

## 2. Calculate defect formation energy

Identify important intrinsic defects, dopants, impurities and defect-pairs



## 3. Model thermodynamic properties

Defect and free carrier concentrations as function of  $T$  and  $pO_2$ ,  $pH_2O$

(Courtesy: S. Lany)

Defect formation energy

$$\Delta H = \Delta H_{D,q}(\mu, E_F)$$

Defect concentration

$$c_D \approx N_{\text{site}} \times \exp(-\Delta H/kT)$$

Electron/hole density

$$c_e = \int f_{FD}(E - E_F) g(E) dE$$

Charge neutrality

$$-c_e + c_h + \sum [q \cdot c(D^q)] = 0$$

Self-consistent solution

$$\Delta H(E_F) \longrightarrow c_D(\Delta H) \longrightarrow E_F$$

$pO_2$  dependence of  $\mu_O$   
(ideal gas)

$$\Delta \mu_O(T, P_0) = \frac{1}{2} [H_0 + \Delta H(T)] - \frac{1}{2} T \cdot [S_0 + \Delta S(T)]$$

$$\Delta \mu_O(T, P) = \Delta \mu_O(T, P_0) + \frac{1}{2} k T \ln(P/P_0)$$

O, H chemical potentials outcome of  $H_2 + \frac{1}{2} O_2 \leftrightarrow H_2O$  gas equilibrium

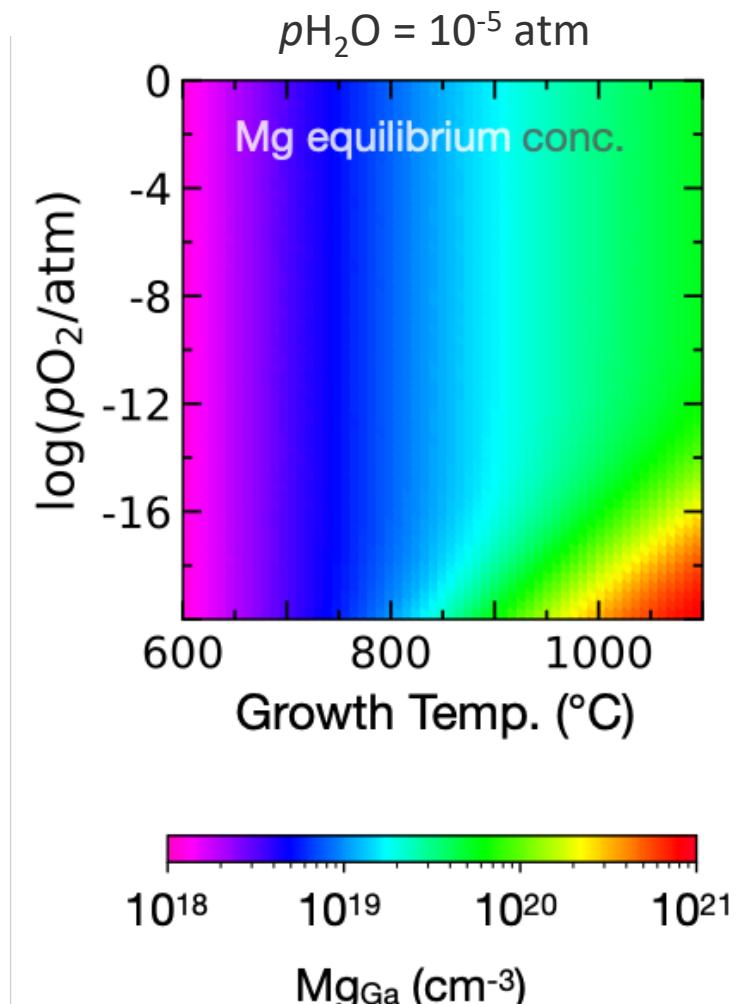
# Growth at O-poor and H-rich Conditions

Typical thin-film growth conditions:

Typical Like-Process	Temp. (°C)	range $pO_2$ (atm)	max $pH_2O$ (atm) <sup>1,2</sup>
PVD	600 - 800	$10^{-13} - 10^{-5}$	$10^{-5}$
CVD	800 - 1100	$10^{-18} - 10^0$	$10^0$

Under H-rich conditions ( $pH_2O = 10^{-5}$  atm) Mg solubility less sensitive to  $pO_2$

Mg conc. under Growth

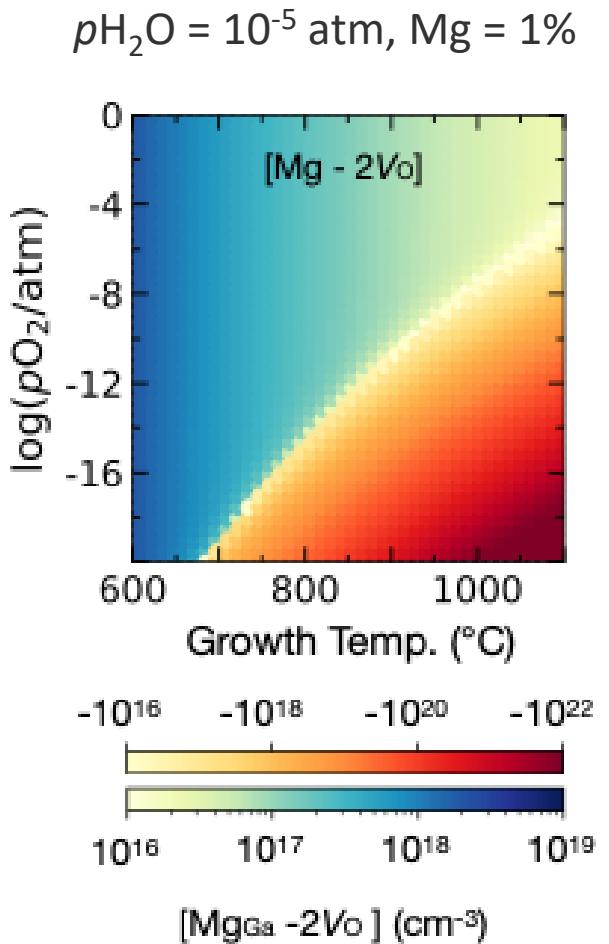
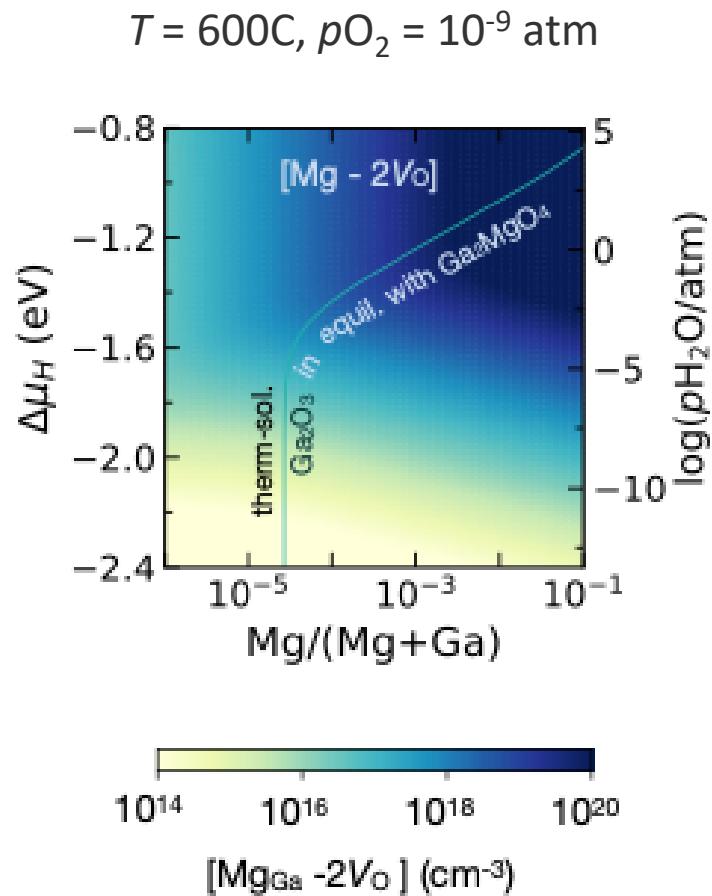


<sup>1</sup>Upper limit of ballistic particle transfer across chamber in PVD process such as MBE or PLD

<sup>2</sup>In APCVD if  $H_2O$  is used as oxygen precursor for  $Al_2O_3$  growth

# Growth Step: Beyond Mg Equilibrium Solubility

- Beyond equilibrium Mg solubility feasible in thin-film growth<sup>1,2</sup> and under atmospheric pressure chemical vapor (APCVD) process<sup>3</sup>
- Even higher Mg solubility possible under hydrogen plasma source<sup>4</sup>



**Lower growth  $T$  and H-rich conditions required to maximize  $[\text{Mg} - 2V_{\text{O}}]$  defect concentration**

<sup>1</sup>G. B. Gonzalez et al., *J. Am. Ceram. Soc.* 95, 2012, 809-815

<sup>2</sup>M. H. Wong et al., *Appl. Phys. Lett.* 2018, 113 102103

<sup>3</sup>T. Terasako et al., *Phys. Status Solidi C* 12, 2015, 985-988

<sup>4</sup>L. Tian et al., *Surface & Coatings Tech.* 347, 2018, 181-190

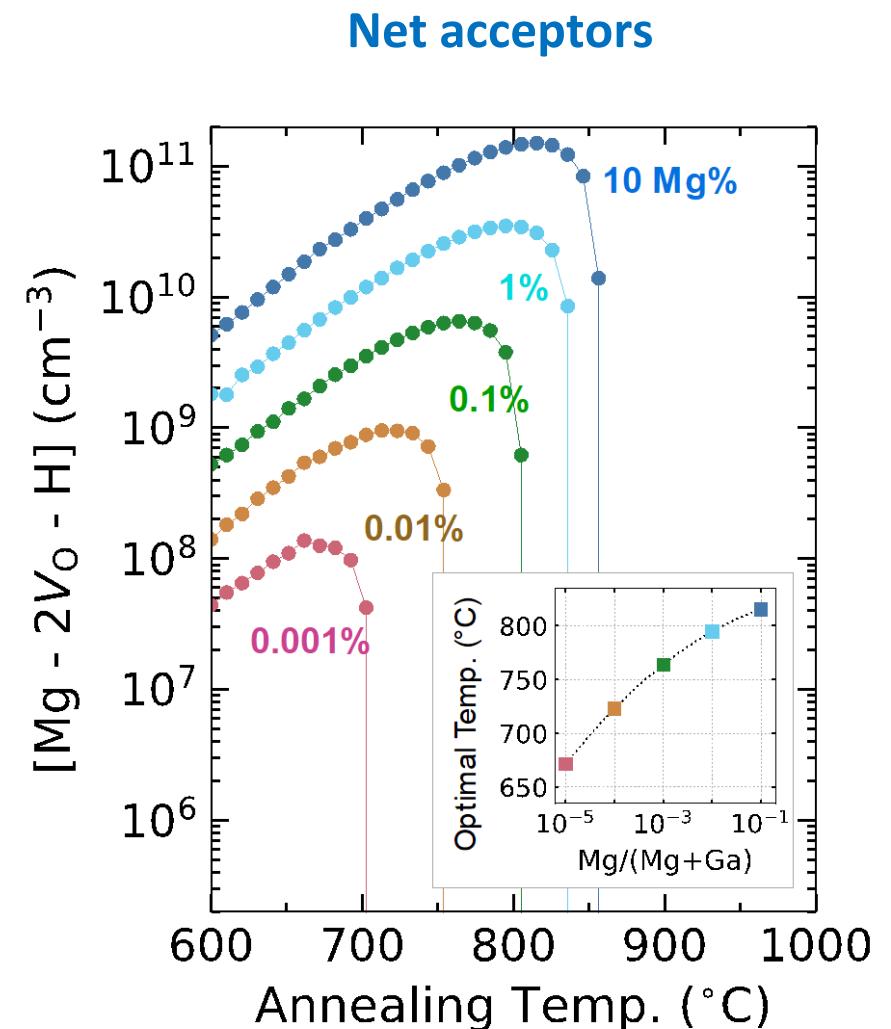
# Equilibrium Anneal at O-rich and H-poor Conditions

- Allow for O vacancies and H to equilibrate
- Conditions analogous to Mg:GaN<sup>1,2</sup> (N-rich/H-poor)
- O-rich:  $pO_2 = 1 \text{ atm}$
- H-poor\*:  $pH_2O = 10^{-8} \text{ atm}$

\*Choice of  $pH_2O$ :

- Research grade gas typically contains 1 ppm  $pH_2O = 10^{-6} \text{ atm}$
- Gases can be further purified (gas chromatography)
- Impurity level 10 ppb possible =  $10^{-8} \text{ atm}$

Optimal annealing temperature that maximizes net acceptors for Mg-doping level



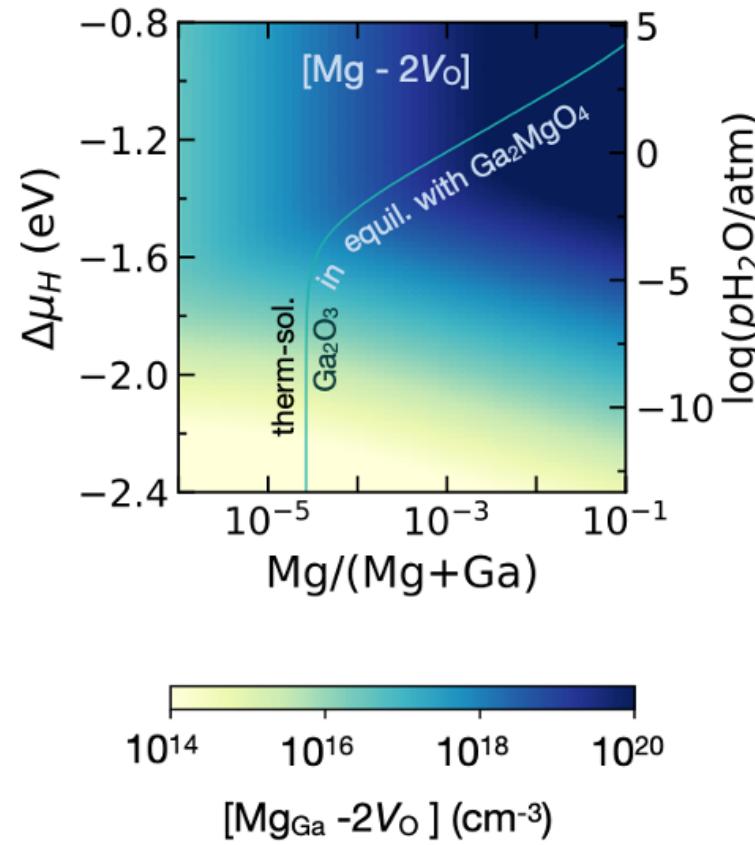
<sup>1</sup>S. Nakamura et al., *Jpn. J. Appl. Phys.*, **1992**, 31, 1258–1266

<sup>2</sup>S. Nakamura et al., *Jpn. J. Appl. Phys.*, **1992**, 31, L139–L142

# Non-Equilibrium Anneal at Fixed $V_O$ Concentration

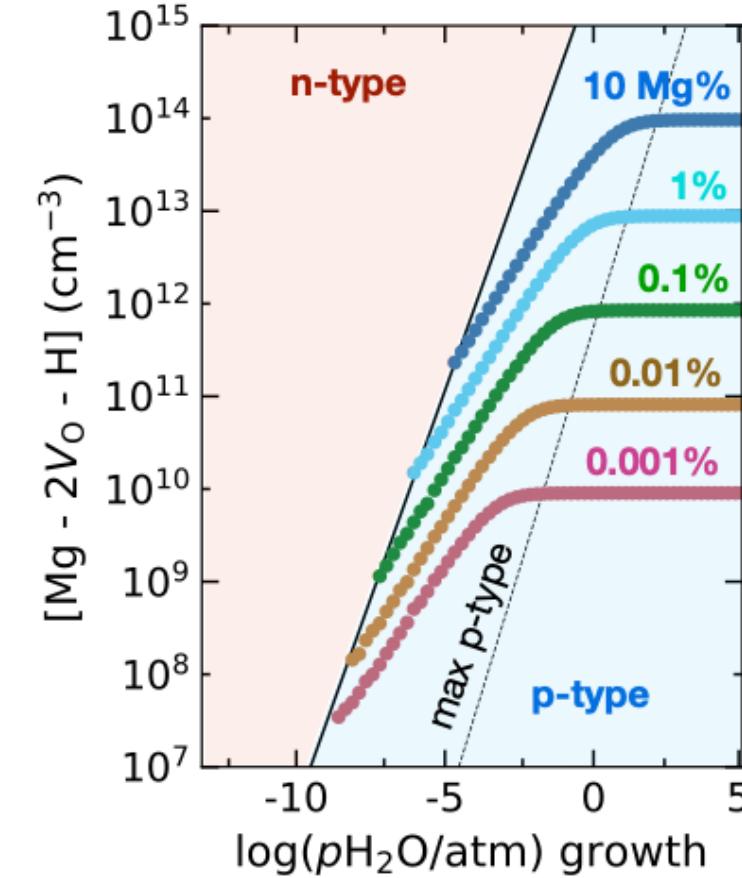
## Growth

$T = 600^\circ\text{C}$ ,  $p\text{O}_2 = 10^{-9}$  atm



## Non-equilibrium Anneal

$T = 600^\circ\text{C}$ ,  $p\text{O}_2 = 1\text{ atm}$ ,  $p\text{H}_2\text{O} = 10^{-8}$  atm



Higher conc. of net acceptors than at the equilibrium annealing

Kyrtos et al. Phys. Rev. B, **2017**, 95, 245202

M. H. Wong et al., Appl. Phys. Lett. **2018**, 113 102103

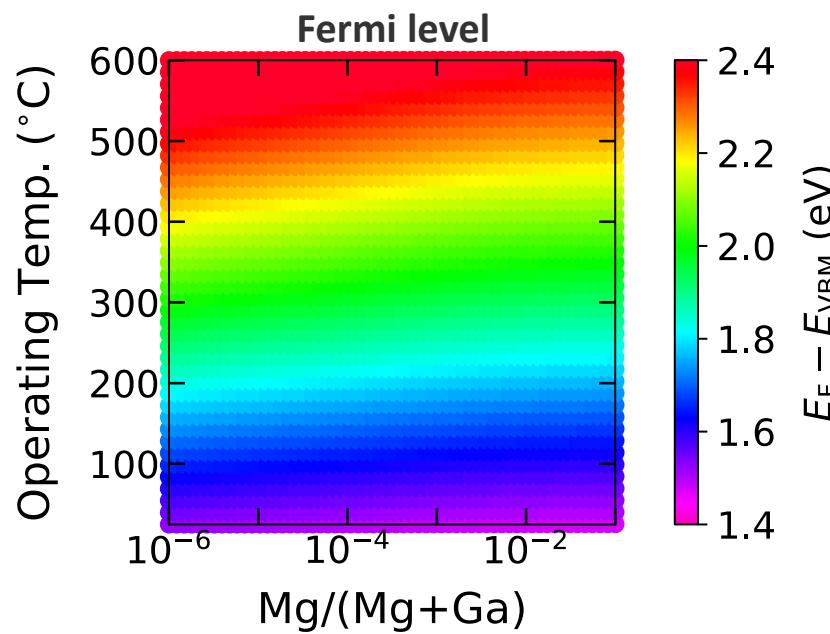
H. Peelaers et al. APL Mater. **2019**, 7, 2022519

Minimum  $p\text{H}_2\text{O}$  needed during growth for conversion ( $N_A > N_D$ )

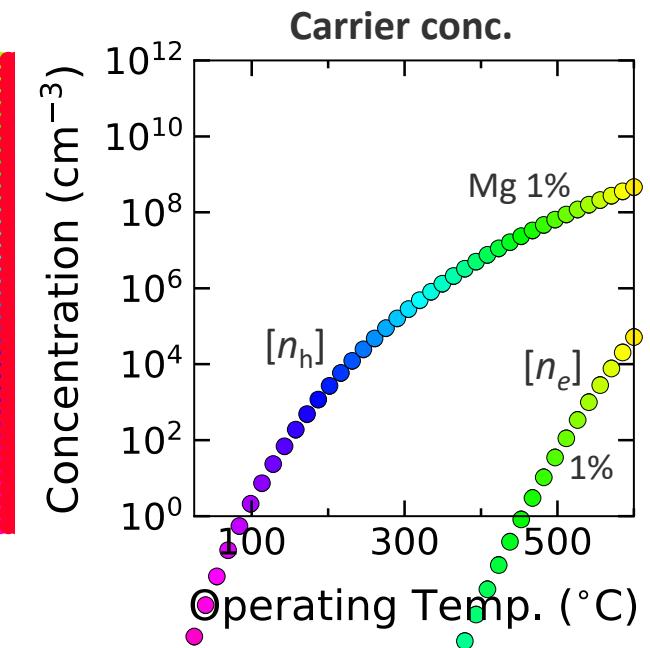
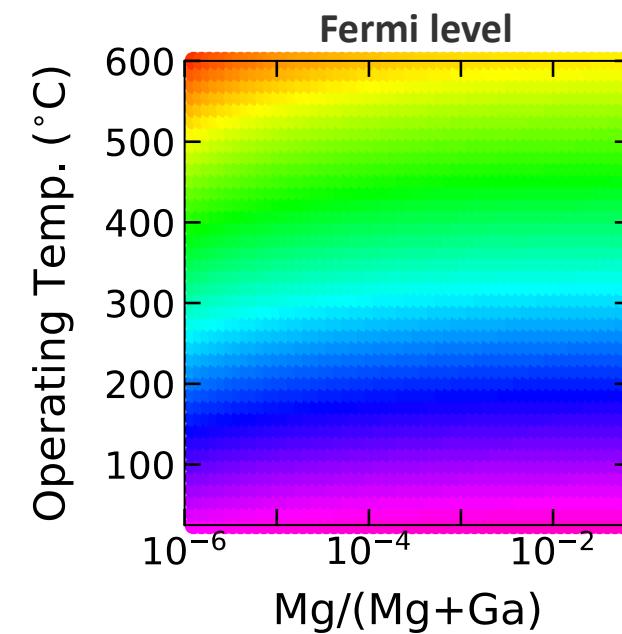
# Quench From the Preceding Annealing Step

- Quenched from the preceding anneal step at  $pO_2 = 1 \text{ atm}$ ,  $pH_2O = 10^{-8} \text{ atm}$
- Freeze defect concentrations and allow for Fermi level, electrons and holes to equilibrate

Quench from equilibrium anneal



Quench from non-equilibrium anneal

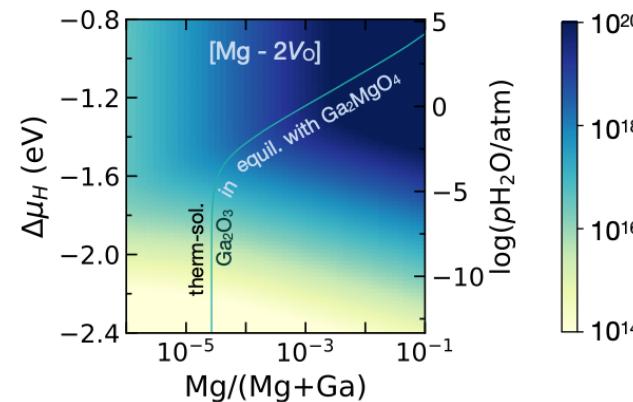


Fermi level has stronger dependence on operating temperature and  $[n_e]$  greatly suppressed

# Three-step Processing of Mg-doped Ga<sub>2</sub>O<sub>3</sub> with H

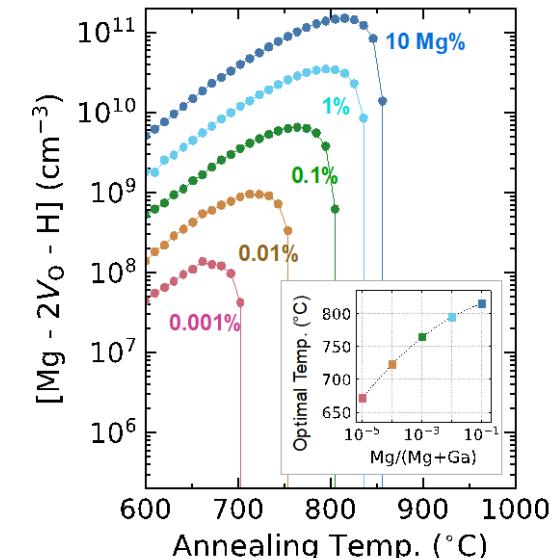
## Growth:

- Lower growth  $T$  is better
- H-rich  $p\text{H}_2\text{O} > 10^{-7}$  atm needed to enable type conversion ( $N_A > N_D$ )



## Equilibrium Anneal:

- Optimal anneal temperature to maximize net acceptors  $\sim 10^7\text{-}10^{11}\text{ cm}^{-3}$

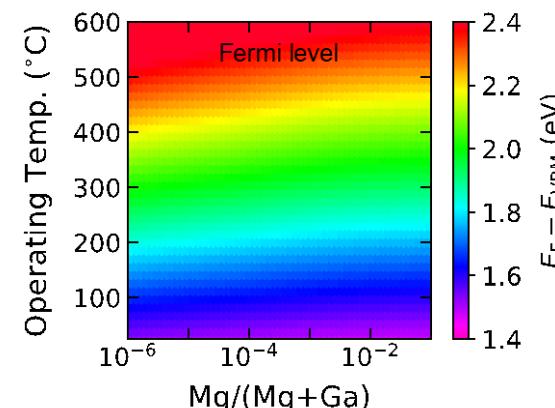


## Non-equilibrium Anneal:

- If achievable, result in higher net acceptors  $\sim 10^{10}\text{-}10^{14}\text{ cm}^{-3}$  than equilibrium annealing

## Quench:

- $E_F$  below mid gap value
- Electron concentrations can be greatly suppressed



# Thank you!